

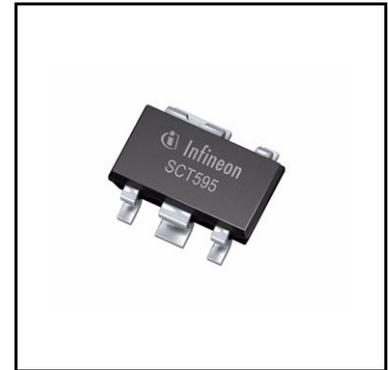
# IFX20001

## Low dropout voltage regulator



### Features

- Two output voltage versions: 3.3 V, 5.0 V
- Low drop voltage  $\leq 300$  mV over the full temperature range
- Output current: 30 mA
- Inhibit function
- Low quiescent current
- Input voltage up to 45 V
- Wide temperature range:  $T_j = -40^\circ\text{C}$  to  $+125^\circ\text{C}$
- Output protected against short circuit
- Overtemperature protection
- Reverse polarity protection
- Very small and thermally enhanced package
- Green Product (RoHS compliant)



### Potential applications

- Manufacturing automation
- Appliances
- Network routers

The IFX20001 is not qualified and manufactured according to the requirements of Infineon Technologies with regards to automotive and/or transportation applications. For automotive applications please refer to the Infineon TLx (TLE, TLS, TLF, ...) voltage regulator products.

### Product validation

Qualified for industrial applications according to the relevant tests of JEDEC.

### Description

The IFX20001 is a monolithic integrated low drop voltage regulator in a very small SMD package PG-SCT595-5. It is designed to supply various loads (e.g. microcontrollers, sensors, or as stand-by supply, etc.) under severe conditions. Therefore the device is equipped with additional protection functions against overload, short circuit and reverse polarity. In case of an overtemperature condition the regulator is automatically turned off by the integrated thermal protection circuit.

Input voltages up to 40 V are regulated to  $V_{Q,nom} = 3.3$  V (V33 version) or 5.0 V (V50 version). The output is able to drive a load of 30 mA while it regulates the output voltage within a 4% accuracy. To save energy the device can be switched to stand-by mode via an inhibit input which causes the current consumption to drop below 5  $\mu$ A.

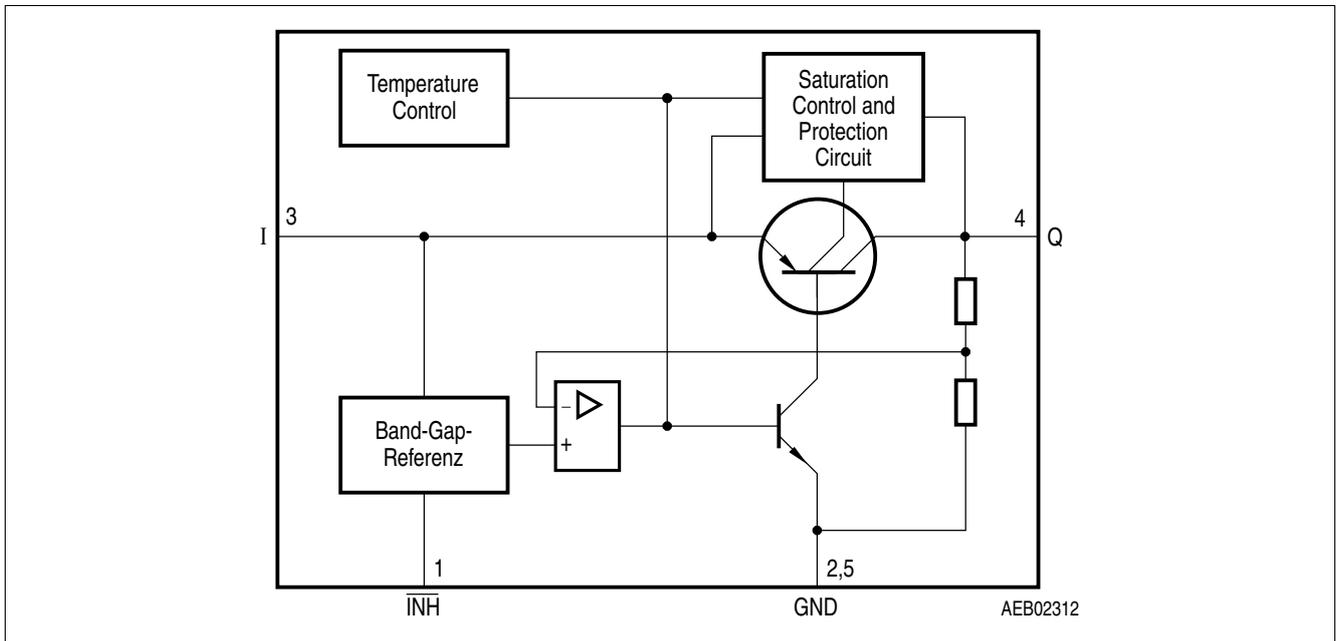
<b>Type</b>	<b>Package</b>	<b>Marking</b>
IFX20001MBV33	PG-SCT595-5	V3
IFX20001MBV50	PG-SCT595-5	V5

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**Block diagram**

**1 Block diagram**

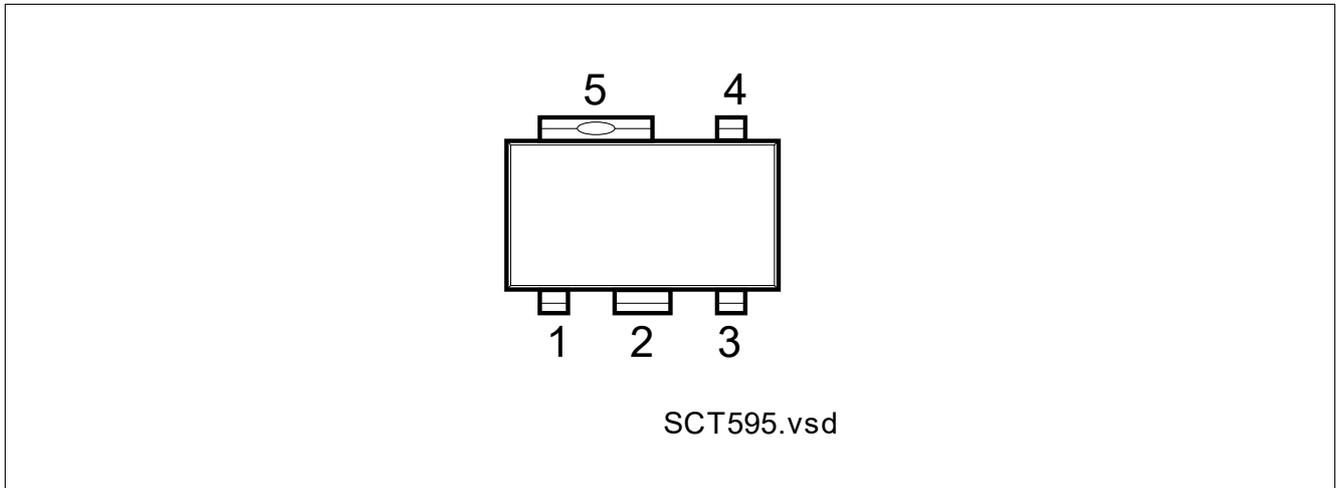


**Figure 1 Block diagram**

**Pin configuration**

**2 Pin configuration**

**2.1 Pin assignment**



**Figure 2 Pin configuration (top view)**

**2.2 Pin definitions and functions**

**Table 1 Pin definitions and functions fixed output voltage versions**

Pin	Symbol	Function
1	$\overline{\text{INH}}$	<b>Inhibit input</b> High level to turn on the IC.
2	GND	<b>Ground</b> Connected to pin 5.
3	I	<b>Input voltage</b>
4	Q	<b>Output voltage</b> Must be blocked with a ceramic capacitor $C_Q \geq 3.3 \mu\text{F}$ . <sup>1)2)</sup>
5	GND	<b>Ground</b> Connected to pin 2.

1) Output capacitor requirements for IFX20001MBV33:  $C_Q \geq 3.3 \mu\text{F}$ , ESR = 2.5  $\Omega$  to 6  $\Omega$ .

2) Output capacitor requirements for IFX20001MBV50:  $C_Q \geq 3.3 \mu\text{F}$ , ESR = 2.5  $\Omega$  to 8  $\Omega$ .

**General product characteristics**

### 3 General product characteristics

#### 3.1 Absolute maximum ratings

**Table 2 Absolute maximum ratings<sup>1)</sup>**

$T_j = -40^\circ\text{C}$  to  $150^\circ\text{C}$ ; all voltages with respect to ground, positive current flowing into pin (unless otherwise specified)

Parameter	Symbol	Values			Unit	Note or Test Condition	Number
		Min.	Typ.	Max.			
<b>Input I</b>							
Voltage	$V_I$	-42	-	45	V	-	P_3.1.1
Current	$I_I$	-	-	-		<sup>2)</sup>	
<b>Output Q</b>							
Voltage	$V_Q$	-6	-	30	V	-	P_3.1.2
Current	$I_I$	-	-	-		<sup>2)</sup>	
<b>Inhibit</b>							
Voltage	$V_{\overline{\text{INH}}}$	-42	-	45	V	-	P_3.1.3
Current	$I_{\overline{\text{INH}}}$	-500	-	<sup>2)</sup>	$\mu\text{A}$	-	P_3.1.4
		-5	-	5	mA	$-0.3\text{ V} \leq V_I \leq 45\text{ V};$ $t_p < 1\text{ ms}$	P_3.1.5
<b>Temperatures</b>							
Junction temperature	$T_j$	-40	-	150	$^\circ\text{C}$	-	P_3.1.6
Storage temperature	$T_{\text{stg}}$	-50	-	150	$^\circ\text{C}$	-	P_3.1.7

1) Not subject to production test, specified by design.

2) Internally limited.

#### Notes

1. Stresses above the ones listed here may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
2. Integrated protection functions are designed to prevent IC destruction under fault conditions described in the data sheet. Fault conditions are considered as "outside" normal operating range. Protection functions are not designed for continuous repetitive operation.

**General product characteristics**

**3.2 Functional range**

**Table 3 Functional range**

Parameter	Symbol	Values			Unit	Note or Test Condition	Number
		Min.	Typ.	Max.			
Input voltage	$V_I$	4.0	–	45	V	IFX20001MBV33	P_3.2.1
		5.5	–	45	V	IFX20001MBV50	P_3.2.2
Inhibit voltage	$V_{INH}$	-0.3	–	40	V	–	P_3.2.3
Junction temperature	$T_j$	-40	–	125	°C	–	P_3.2.4

*Note:* Within the functional or operating range, the IC operates as described in the circuit description. The electrical characteristics are specified within the conditions given in the electrical characteristics table.

**3.3 Thermal resistance**

*Note:* This thermal data was generated in accordance with JEDEC JESD51 standards. For more information, go to [www.jedec.org](http://www.jedec.org).

**Table 4 Thermal resistance**

Parameter	Symbol	Values			Unit	Note or Test Condition	Number
		Min.	Typ.	Max.			
Junction to ambient	$R_{thJA}$	–	81	–	K/W	2s2p board <sup>1)</sup>	P_3.3.1
		–	217	–	K/W	Footprint only <sup>2)</sup>	P_3.3.2
		–	117	–	K/W	300 mm <sup>2</sup> PCB heatsink area <sup>2)</sup>	P_3.3.3
		–	103	–	K/W	600 mm <sup>2</sup> PCB heatsink area <sup>2)</sup>	P_3.3.4
Junction to soldering point	$R_{thJSP}$	–	30	–	K/W	Pins 2, 5 fixed to $T_A$	P_3.3.5

- 1) Specified  $R_{thJA}$  value is according to Jedec JESD51-2,-5,-7 at natural convection on FR4 2s2p board; The product (chip+package) was simulated on a 76.2 × 114.3 × 1.5 mm<sup>3</sup> board with 2 inner copper layers (2 × 70 μm Cu, 2 × 35 μm Cu). Where applicable a thermal via array under the exposed pad contacted the first inner copper layer.
- 2) Package mounted on PCB FR4; 80 × 80 × 1.5 mm<sup>3</sup>, 35 μm Cu, 5 μm Sn; horizontal position; zero airflow. Not subject to production test; specified by design.

**Electrical characteristics**

**4 Electrical characteristics**

**4.1 Electrical characteristics voltage regulator**

**Table 5 Electrical characteristics voltage regulator**

$V_I = 13.5\text{ V}$ ;  $V_{\text{INH}} > 2.5\text{ V}$ ;  $T_j = -40^\circ\text{C}$  to  $+125^\circ\text{C}$ ; all voltages with respect to ground (unless otherwise specified)

Parameter	Symbol	Values			Unit	Note or Test Condition	Number
		Min.	Typ.	Max.			
Output voltage IFX20001MBV33	$V_Q$	3.17	3.30	3.43	V	$1\text{ mA} \leq I_Q \leq 30\text{ mA}$ $V_I = 13.5\text{ V}$	P_5.1.1
		3.17	3.30	3.43	V	$I_Q = 10\text{ mA}$ ; $4.3\text{ V} \leq V_I \leq 40\text{ V}$	P_5.1.2
Output voltage IFX20001MBV50	$V_Q$	4.80	5.00	5.20	V	$1\text{ mA} \leq I_Q \leq 30\text{ mA}$ $V_I = 13.5\text{ V}$	P_5.1.18
		4.80	5.00	5.20	V	$I_Q = 10\text{ mA}$ ; $6\text{ V} \leq V_I \leq 40\text{ V}$	P_5.1.19
Output current limitation	$I_Q$	30	–	–	mA	<sup>1)</sup>	P_5.1.3
Dropout voltage <sup>1)</sup>	$V_{\text{dr}}$	–	250	300	mV	$I_Q = 20\text{ mA}$	P_5.1.4
Output capacitor	$C_Q$	3.3	–	–	$\mu\text{F}$	IFX20001MBV33: $2.5\ \Omega \leq \text{ESR} \leq 6\ \Omega$ at 10 kHz	P_5.1.5
		3.3	–	–	$\mu\text{F}$	IFX20001MBV50: $2.5\ \Omega \leq \text{ESR} \leq 8\ \Omega$ at 10 kHz	P_5.1.20
Current consumption $I_q = I_I - I_Q$	$I_q$	–	2	4.5	mA	$I_Q < 30\text{ mA}$	P_5.1.6
		–	110	170	$\mu\text{A}$	$I_Q < 1\text{ mA}$ ; $T_j < 85^\circ\text{C}$	P_5.1.7
Quiescent current (stand-by) $I_q = I_I - I_Q$	$I_q$	–	–	1	$\mu\text{A}$	$V_{\text{INH}} = 0.4\text{ V}$ ; $T_j < 85^\circ\text{C}$	P_5.1.8
		–	–	5	$\mu\text{A}$	$V_{\text{INH}} = 0.4\text{ V}$	P_5.1.9
Load regulation	$\Delta V_Q$	–	10	20	mV	$1\text{ mA} < I_Q < 25\text{ mA}$ ; $T_j = 25^\circ\text{C}$ ;	P_5.1.10
Line regulation	$\Delta V_Q$	–	5	20	mV	$V_I = (V_{Q,\text{nom}} + 0.5\text{ V})$ to $36\text{ V}$ ; $I_Q = 5\text{ mA}$ ; $T_j = 25^\circ\text{C}$	P_5.1.12
Power supply ripple rejection	PSRR	–	60	–	dB	$f_r = 100\text{ Hz}$ ; $V_r = 0.5\text{ V}_{\text{pp}}$	P_5.1.13

**Logic Inhibit input**

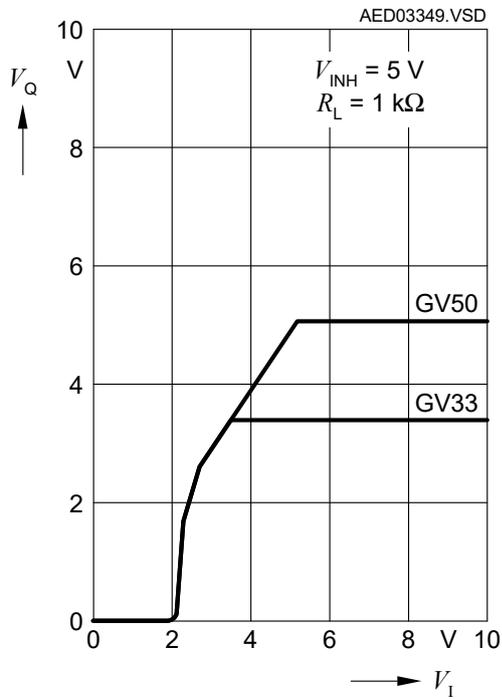
Inhibit, turn-on voltage	$V_{\text{INH,high}}$	–	–	2.2	V	$V_Q > 0.95 \times V_{Q,\text{nom}}$	P_5.1.14
Inhibit, turn-off voltage	$V_{\text{INH,low}}$	0.4	–	–	V	$V_Q < 0.1\text{ V}$	P_5.1.15
H-input current	$V_{\text{INH,high}}$	–	8	12	$\mu\text{A}$	$V_{\text{INH}} = 5\text{ V}$	P_5.1.16
L-input current	$V_{\text{INH,low}}$	-2	–	2	$\mu\text{A}$	$V_{\text{INH}} = 0\text{ V}$	P_5.1.17

<sup>1)</sup> Measured when the output voltage  $V_Q$  has dropped 100 mV from the nominal value.

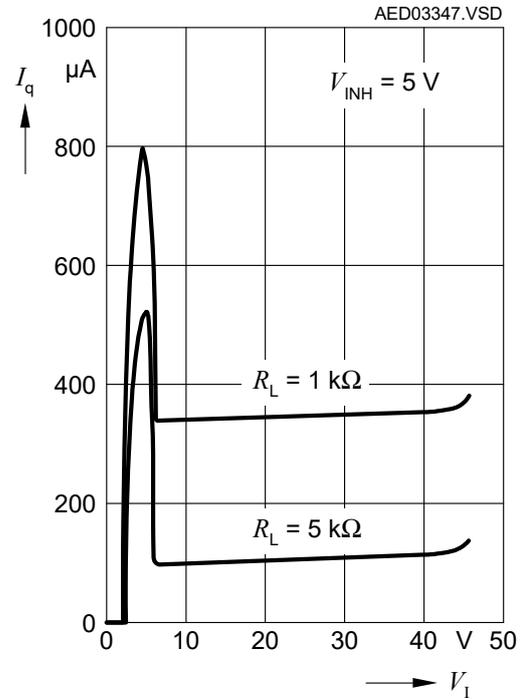
**Electrical characteristics**

**4.2 Typical performance characteristics voltage regulator**

**Output voltage  $V_Q$  vs. input voltage  $V_I$**



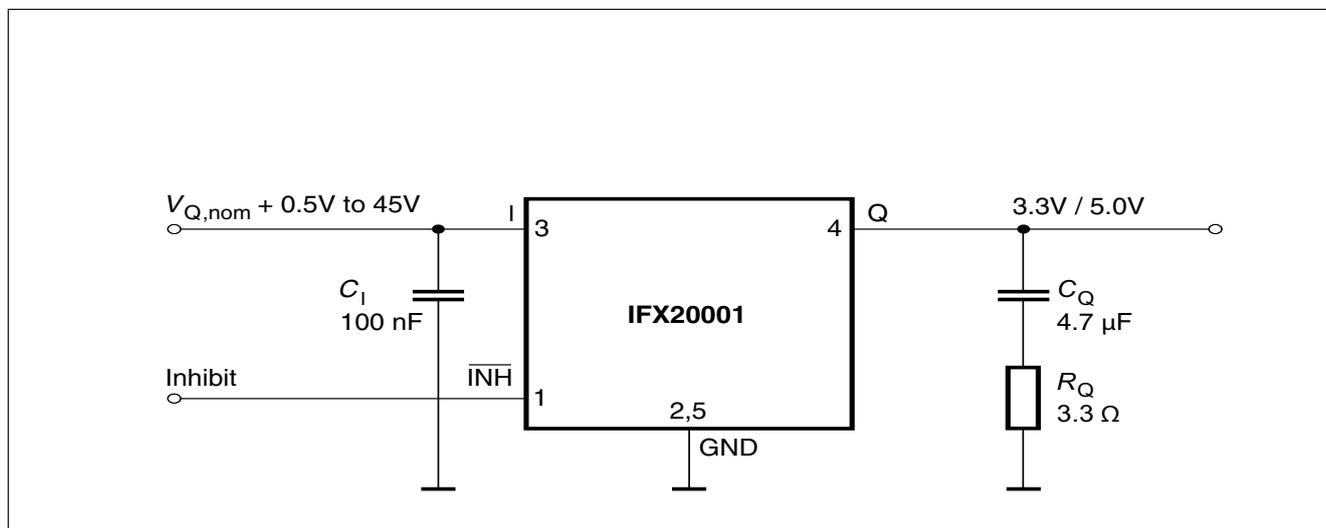
**Current consumption  $I_q$  vs. input voltage  $V_I$**



**Application information**

**5 Application information**

*Note: The following information is given as a hint for the implementation of the device only and shall not be regarded as a description or warranty of a certain functionality, condition or quality of the device.*



**Figure 3 Application diagram**

The output voltage of the IFX20001 is divided and compared to an internal reference of 2.5 V typical. A regulation loop controls the output to achieve a stabilized output voltage.

**Figure 3** shows a typical application circuit. In order to maintain the stability of the control loop the IFX20001 output requires an output capacitor  $C_Q$  of at least 3.3  $\mu\text{F}$  with a minimum required ESR of 2.5  $\Omega$  and a maximum allowed ESR of 6  $\Omega$  for the IFX20001MBV33 and 8  $\Omega$  for the IFX20001MBV50. It is recommended to use for  $C_Q$  a suitable tantalum capacitor or a multilayer ceramic capacitor with a sufficiently dimensioned series resistor in order to cover the required ESR range over the full operating temperature range of  $T_j = -40^\circ\text{C}$  to  $+125^\circ\text{C}$ .<sup>1)</sup>

At the input of the regulator a capacitor is required for compensating line influences (100 nF ceramic capacitor recommended). A resistor of approximately 1  $\Omega$  in series with the input capacitor  $C_1$  can dampen oscillations that could occur due to the input line inductance and the input capacitor.

1) For usage of ceramic capacitors without applying an additional series resistor at the output please refer to the IFX20002 which is a corresponding voltage regulator series specially designed for the usage of low-ESR output capacitors (< 2  $\Omega$ ).

## 6 Package information

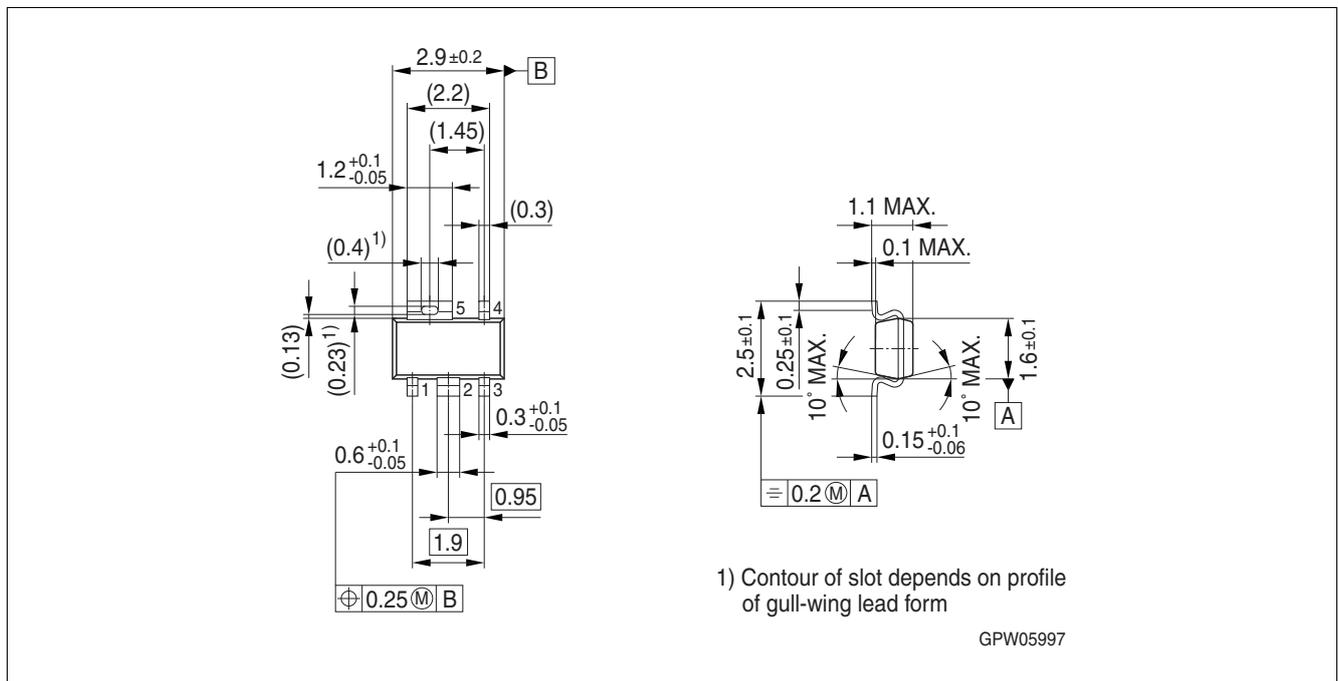


Figure 4 PG-SCT595-5<sup>1)</sup>

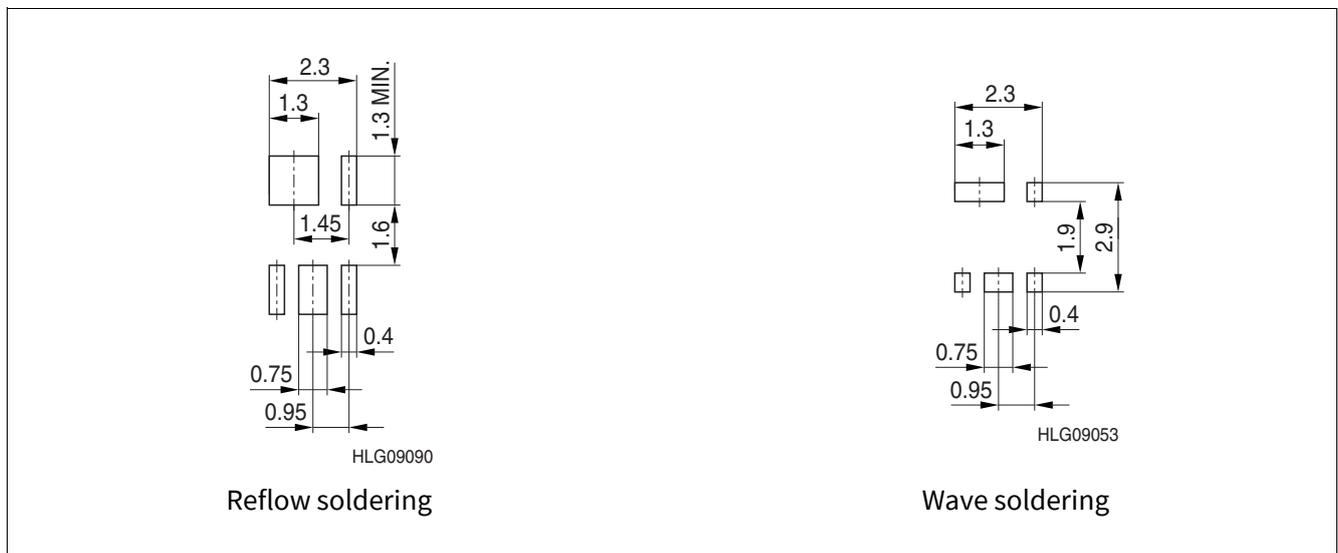


Figure 5 Footprint PG-SCT595-5<sup>1)</sup>

### Green Product (RoHS compliant)

To meet the world-wide customer requirements for environmentally friendly products and to be compliant with government regulations the device is available as a green product. Green products are RoHS-compliant (i.e. Pb-free finish on leads and suitable for Pb-free soldering according to IPC/JEDEC J-STD-020).

### Further information on packages

<https://www.infineon.com/packages>

1) Dimensions in mm

**Revision history**

## 7 Revision history

<b>Revision</b>	<b>Date</b>	<b>Changes</b>
1.20	2021-05-11	Updated layout and structure Editorial changes Added TOC
1.1	2013-01-08	Corrected ESR requirements for output capacitor (Chapter 3.2, Table 1 / Chapter 5.1, Table 2 / Chapter 6, "Application information") Added remarks/footnotes with respect to ESR (Chapter 6) Updated application diagram (Figure 3) Updated (improved) limits of parameters current consumption, line regulation and load regulation in electrical characteristics (Chapter 5.1, Table 2). Adapted test condition for current consumption Updated minimum limit for absolute maximum ratings of $V_Q$ (Chapter 4.1) Further editorial changes
1.02	2010-05-20	Editorial change (Figure 3)
1.01	2009-09-10	Editorial changes: updated coverpage Overview page: inserted reference statement to TLE/TLF series
1.0	2009-04-28	Initial release

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